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## $\pm 15 k V$ ESD-Protected, Single/Dual/Octal, CMOS Switch Debouncers

## General Description

The MAX6816/MAX6817/MAX6818 are single, dual, and octal switch debouncers that provide clean interfacing of mechanical switches to digital systems. They accept one or more bouncing inputs from a mechanical switch and produce a clean digital output after a short, preset qualification delay. Both the switch opening bounce and the switch closing bounce are removed. Robust switch inputs handle $\pm 25 \mathrm{~V}$ levels and are $\pm 15 \mathrm{kV}$ ESD-protected for use in harsh industrial environments. They feature single-supply operation from +2.7 V to +5.5 V . Undervoltage-lockout circuitry ensures the output is in the correct state upon power-up.
The single MAX6816 and dual MAX6817 are offered in SOT packages and require no external components. Their low supply current makes them ideal for use in portable equipment.
The MAX6818 octal switch debouncer is designed for data-bus interfacing. The MAX6818 monitors switches and provides a switch change-of-state output $(\overline{\mathrm{CH}})$, simplifying microprocessor ( $\mu \mathrm{P}$ ) polling and interrupts. Additionally, the MAX6818 has three-state outputs controlled by an enable ( $\overline{\mathrm{EN}}$ ) pin, and is pin-compatible with the LS573 octal latch (except for the $\overline{\mathrm{CH}} \mathrm{pin}$ ), allowing easy interfacing to a digital data bus.

## Applications

- $\mu \mathrm{P}$ Switch Interfacing
- Industrial Instruments
- PC-Based Instruments
- Portable Instruments
- Membrane Keypads


## Pin Configurations



Pin Configurations continued at end of data sheet.

## Benefits and Features

- Switch Debouncer Integration Simplifies System Interface to Mechanical Switches
- Single-Supply Operation from +2.7 V to +5.5 V
- No External Components Required
- Single (MAX6816), Dual (MAX6817), and Octal (MAX6818) Versions Available
- $6 \mu \mathrm{~A}$ Supply Current
- Built-In Protection Circuitry Improves System

Reliability

- Inputs Can Exceed Power Supplies up to $\pm 25 \mathrm{~V}$
- ESD Protection for Input Pins
- $\pm 15 \mathrm{kV}$ —Human Body Model
- $\pm 8 \mathrm{kV}$ —IEC 1000-4-2, Contact Discharge
- $\pm 15 \mathrm{kV}$ —IEC 1000-4-2, Air-Gap Discharge
- Octal Version (MAX6818) Provides Direct Data Bus Interface
- Three-State Outputs for Directly Interfacing to $\mu \mathrm{P}$ (MAX6818)
- Switch Change-of-State Output Simplifies Polling and Interrupts (MAX6818)
- Pin-Compatible with 'LS573 (MAX6818)


## Ordering Information

| PART | TEMP RANGE | PIN- <br> PACKAGE | SOT <br> TOP MARK |
| :--- | :--- | :--- | :---: |
| MAX6816EUS-T | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 4 SOT143 | KABA |
| MAX6817EUT-T | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6 SOT23-6 | AAAU |
| MAX6818EAP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20 SSOP | - |

Note: There is a minimum order increment of 2500 pieces for SOT packages.
Devices are available in both leaded and lead(Pb)-free/RoHScompliant packaging. Specify lead-free by replacing " $T$ " with " $+T$ " when ordering.

## Typical Operating Circuit



| Absolute Maximum Ratings |  |
| :---: | :---: |
| Voltage (with respect to GND) |  |
| $\mathrm{V}_{\mathrm{CC}}$ | 3 V to +6 V |
| IN_ (Switch Inputs) | -30V to +30 V |
| EN. | -0.3V to +6V |
| OUT_, $\overline{\mathrm{CH}}$ | -0.3 V to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |
| OUT Short-Circuit Duration |  |
| (One or Two Outputs to GND). |  |
| Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ ) |  |
| 4 -Pin SOT143 (derate 4.0 mW | +70 ${ }^{\circ} \mathrm{C}$ ) ....... 320 mW |


| Pin SOT23 (derate $8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) ......... 691 mW |  |
| :---: | :---: |
|  |  |
| Operating Temperature Range...................... $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range ......................... $65^{\circ} \mathrm{C}$ to $+160^{\circ} \mathrm{C}$ |  |
| Lead Temperature (soldering, 10s) .............................. $+300^{\circ} \mathrm{C}$ |  |
| Soldering Temperature (reflow) |  |
| Lead | $+260^{\circ} \mathrm{C}$ |
|  |  |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{CC}}=+2.7 \mathrm{~V}\right.$ to $+5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)


Note 1: MAX6816 and MAX6817 production testing is done at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$; overtemperature limits are guaranteed by design.



DEBOUNCE DELAY PERIOD vs. TEMPERATURE



VCC UNDERVOLTAGE LOCKOUT vs. TEMPERATURE


## Pin Description

| PIN |  |  | NAME |  |
| :---: | :---: | :---: | :---: | :--- |
| MAX6816 | MAX6817 | MAX6818 |  | FUNCTION |
| 1 | 2 | 10 | GND | Ground |
| 2 | - | - | IN | Switch Input |
| - | 1,3 | - | IN1, IN2 | Switch Inputs |
| - | - | $2-9$ | IN1-IN8 | Switch Inputs |
| 3 | - | - | OUT | CMOS Debounced Output |
| - | 4,6 | - | OUT2, OUT1 | CMOS Debounced Outputs |
| - | - | $12-19$ | OUT8-OUT1 | CMOS Debounced Outputs |
| 4 | 5 | 20 | VCC | +2.7V to +5.5V Supply Voltage |
| - | - | 1 | $\overline{\text { EN }}$ | Active-Low, Three-State Enable Input for outputs. Resets $\overline{\text { CH. }}$ <br> Tie to GND to "always enable" outputs. |
| - | - | 11 | $\overline{\text { CH }}$ | Change-of-State Output. Goes low on switch input change of <br> state. Resets on EN. Leave unconnected if not used. |



Figure 1. Block Diagram

## Detailed Description

## Theory of Operation

The MAX6816/MAX6817/MAX6818 are designed to eliminate the extraneous level changes that result from interfacing with mechanical switches (switch bounce). Virtually all mechanical switches bounce upon opening or closing. These switch debouncers remove bounce when a switch opens or closes by requiring that sequentially clocked inputs remain in the same state for a number of sampling periods. The output does not change until the input is stable for a duration of 40 ms .
The circuit block diagram (Figure 1) shows the functional blocks consisting of an on-chip oscillator, counter, exclusive-NOR gate, and D flip-flop. When the input
does not equal the output, the XNOR gate issues a counter reset. When the switch input state is stable for the full qualification period, the counter clocks the flip-flop, updating the output. Figure 2 shows the typical opening and closing switch debounce operation. On the MAX6818, the change output $(\overline{\mathrm{CH}})$ is updated simultaneously with the switch outputs.

## Undervoltage Lockout

The undervoltage-lockout circuitry ensures that the out-puts are at the correct state on power-up. While the supply voltage is below the undervoltage threshold (typically 1.9 V ), the debounce circuitry remains transparent. Switch states are present at the logic outputs with no debouce delay.


Figure 2. Input Characteristics


Figure 3. Switch Input $\pm 25 \mathrm{~V}$ Fault Tolerance

## Robust Switch Inputs

The switch inputs on the MAX6816-MAX6818 have overvoltage-clamping diodes to protect against damaging fault conditions. Switch input voltage scan safely swing $\pm 25 \mathrm{~V}$ to ground (Figure 3). Proprietary ESD-protection structures protect against high ESD encountered in harsh industrial environments, membrane keypads, and portable applications. They are designed to withstand $\pm 15 \mathrm{kV}$ per the IEC 1000-4-2 Air-Gap Discharge Test and $\pm 8 \mathrm{kV}$ per the IEC 1000-4-2 Contact Discharge Test.
Since there are $63 \mathrm{k} \Omega$ (typical) pullup resistors connected to each input, driving an input to -25 V draws approximately 0.5 mA (up to 4 mA for eight inputs) from the $\mathrm{V}_{\mathrm{CC}}$ supply. Driving an input to +25 V will cause approximately 0.32 mA of current (up to 2.6 mA for eight


Figure 4. MAX6818 $\mu$ P Interface Timing Diagram


Figure 5. MAX6818 Typical $\mu$ P Interfacing Circuit
inputs) to flow back into the $\mathrm{V}_{\mathrm{CC}}$ supply. If the total system $\mathrm{V}_{\mathrm{CC}}$ supply current is less than the current flowing back into the $\mathrm{V}_{\mathrm{CC}}$ supply, $\mathrm{V}_{\mathrm{CC}}$ will rise above normal levels. In some low-current systems, a zener diode on $\mathrm{V}_{\mathrm{CC}}$ may be required.

## $\pm 15 \mathrm{kV}$ ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The MAX6816-MAX6818 have extra protection against static electricity. Maxim's engineers have developed state-of-the-art structures to protect against ESD of $\pm 15 \mathrm{kV}$ at the switch inputs without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, the MAX6816MAX6818 keep working without latchup, whereas other solutions can latch and must be powered down to remove latchup.


Figure 6a. Human Body ESD Test Model


Figure 6b. Human Body Current Waveform

ESD protection can be tested in various ways; these products are characterized for protection to the following limits:

1) $\pm 15 \mathrm{kV}$ using the Human Body Model
2) $\pm 8 \mathrm{kV}$ using the Contact-Discharge method specified in IEC 1000-4-2
3) $\pm 15 \mathrm{kV}$ using IEC 1000-4-2's Air-Gap method.

## ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

## Human Body Model

Figure 6a shows the Human Body Model and Figure 6 b shows the current waveform it generates when


Figure 7a. IEC 1000-4-2 ESD Test Model


Figure 7b. IEC 1000-4-2 ESD Generator Current Waveform
discharged into a low impedance. This model consists of a 100 pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a $1.5 \mathrm{k} \Omega$ resistor.

## IEC 1000-4-2

The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits. The MAX6816MAX6818 help you design equipment that meets Level 4 (the highest level) of IEC 1000-4-2, without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2, because series resistance is lower in the IEC 1000-4-2 model. Hence, the ESD withstand voltage measured to IEC 1000-4-2 is generally lower than that measured using the Human Body Model. Figure 7a shows the IEC 1000-4-2 model and Figure 7b shows the current waveform for the 8 kV , IEC 1000-4-2, Level 4, ESD Contact-Discharge test.
The Air-Gap test involves approaching the device with a charged probe. The Contact-Discharge method connects the probe to the device before the probe is energized.

## Machine Model

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by contact that occurs with handling and assembly during manufacturing.

## MAX6818 $\mu$ P Interfacing

The MAX6818 has an output enable ( $\overline{\mathrm{EN}}$ ) input that allows switch outputs to be three-stated on the $\mu \mathrm{P}$ data bus until polled by the $\mu \mathrm{P}$. Also, state changes at the switch inputs are detected, and an output ( $\overline{\mathrm{CH}}$ ) goes low after the debounce period to signal the $\mu \mathrm{P}$. Figure 4 shows the timing diagram for enabling outputs and reading data. If the output enable is not used, tie $\overline{E N}$ to GND to "always enable" the switch outputs. If $\overline{\mathrm{EN}}$ is low, $\overline{\mathrm{CH}}$ is always high. If a change of state is not required, leave $\overline{\mathrm{CH}}$ unconnected.

## Pin Configurations (continued)



## Chip Information

SUBSTRATE CONNECTED TO GND PROCESS: BiCMOS

## Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a " + ", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE <br> TYPE | PACKAGE <br> CODE | OUTLINE <br> NO. | LAND <br> PATTERN NO. |
| :---: | :---: | :---: | :---: |
| 4 SOT143 | U4-1 | $\underline{21-0052}$ | $\underline{\underline{90-0183}}$ |
| 6 SOT23 | U6-4 | $\underline{\underline{21-0058}}$ | $\underline{\underline{90-0175}}$ |
| 20 SSOP | A20-1 | $\underline{\underline{21-0056}}$ | $\underline{\underline{90-0094}}$ |

## Revision History

| REVISION <br> NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES <br> CHANGED |
| :---: | :---: | :--- | :---: |
| 0 | $7 / 98$ | Initial release | - |
| 3 | $8 / 10$ | Updated Ordering Information, Electrical Characteristics, Typical Operating <br> Characteristics, and the Undervoltage Lockout section. | $1-4,7$ |
| 4 | $7 / 14$ | No /V OPNs; removed automotive reference from Applications section | 1 |
| 5 | $4 / 15$ | Updated Benefits and Features section | 1 |

